SM4933 THRU SM4937

GROWCHILD ELECTRONICSTM

SURFACE MOUNT FAST RECOVERY RECTIFIER

REVERSE VOLTAGE: 50 to 600 VOLTS FORWARD CURRENT: 1.0 AMPERE

http://www.njzrg.com

FEATURES

· Plastic package has Underwriters Laboratory Flammability Classification 94V-O

- · For surface mounted applications
- · High temperature metallurgically bonded construction
- · Fast switching for high efficiency
- · Cavity-free glass passivated junction
- · Capable of meeting environmental standards of MIL-S-19500
- \cdot High temperature soldering : 260°C /10 seconds at terminals

MECHANICAL DATA

Case: Molded plastic, MELF

Epoxy: UL 94V-O rate flame retardant

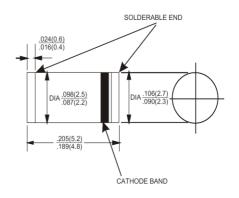
Terminals: Solder plated, solderable per MIL-STD-750,

method 208 guaranteed

Polarity: Color band denotes cathode end

Mounting position: Any Weight: 0.005 ounce, 0.12 gram

MELF



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	SM4933	SM4934	SM4935	SM4936	SM4937	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	Volts
Maximum Average Forward Rectified Current at T_A =55	I _(AV)	1.0					Amp
Peak Forward Surge Current,							
8.3ms single half-sine-wave	I_{FSM}	I _{FSM} 30					
superimposed on rated load (JEDEC method)							
Maximum Forward Voltage at 1.0A DC	$V_{\rm F}$	1.2					Volts
Maximum Reverse Current at T _A =25	ī	5.0					μAmp
at Rated DC Blocking Voltage T _A =125	I_R	100					
Typical Junction Capacitance (Note 1)	C_{J}	15					pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	75					/W
Typical Thermal Resistance (Note 3)	$R_{\theta JT}$	30					/W
Maximum Reverse Recovery Time (Note 4)	T_{RR}	200					nS
Operating and Storage Temperature Range	T _J , Tstg	-55 to +175					

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient, 0.24 x 0.24" (6.0 x 6.0mm) copper pads to each terminal
- 3- Thermal resistance from junction to terminal, 0.24 x 0.24" (6.0 x 6.0mm) copper pads to each terminal
- 4- Reverse Recovery Test Conditions : I_F = 1.0A, V_R = 30V.



RATINGS AND CHARACTERISTIC CURVES

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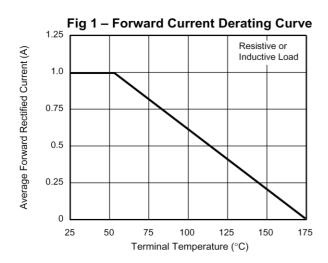


Fig 2 – Maximum Non-repetitive Peak
Forward Surge Current

30

8.3ms Single Half Sine-wave (JEDEC Method)

15

10

Number of Cycles at 60Hz

Fig 3 - Typical Instantaneous Forward Characteristics 10 Instantaneous Forward Current (A) 1 $T_J = 25^{\circ}C$ Pulse width = 300μs 1% Duty Cycle 0.1 0.01 0.4 0.6 8.0 1.0 1.2 1.4 1.6 Instantaneous Forward Voltage (V)

